**ENGINEERING** 

### PRODUCT SPECIFICATION

SPEC.NO.: SPCH083A

DEPT.

For 2.00 mm (.079") Board to Board Connectors of System CH11

**PAGE: 1/3** 

### 1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and below standards base on CviLux test procedure

### 2. APPLICABLE STANDARDS:

MIL - STD - 202 Methods for test of connectors for electronic equipment

EIA 364 Test methods for electrical connectors

J-STD-020 Resistance to soldering Temperature for through hole Mounted Devices SS-00254 Test methods for electronic components ,LEAD-FREE soldering Part

design standards

3. APPLICABLE SERIES NO.: CH11102NB00-A0-PA

CH11232NB00-A0

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

 $0.8 \text{ mm} (.031'') \sim 1.6 \text{ mm} (.063'')$ 



REVIEWED: <u>Eisley</u> APPROVED: <u>Eisley</u> VERIFIED: <u>Sandy</u>.



ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCH083A
DEPT.	For 2.00 mm (.079") Board to Board Connectors of System CH11	PAGE:	2/3

# 7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		2A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max. 100 mA max.	Less than 20 m $\Omega$
7.3	Dielectric strength	When applied AC 500 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 5000 M $\Omega$

# 8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Apply axial pull out force at $25 \pm 3$ mm/min on the assembly in the housing	More than 0.8 Kgf

# 9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Cold Resistance	-40°C ± 3°C, 96 hours	Appearance: No damage Contact resistance:
			$\Delta 20 \ \mathrm{m}\Omega$ change
9.2	Heat Resistance	105°C ± 3°C, 96 hours	Appearance: No damage Contact resistance: $\triangle 20 \text{ m}\Omega$ change
9.3	Temperature Cycling	5 cycles (1) -40 °C, 30 min. (2)Room temp. 10-15 min. (3) 105 °C, 30 min. (4)Room temp. 10-15 min.	Appearance: No damage Contact resistance: $ \Delta 20 \text{ m}\Omega \text{ change} $
9.4	Salt Spray	Temperature: 35± 2°C Solution: 5± 1% Spray time: 6± 1 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: $\triangle 20 \text{ m}\Omega$ max out.



PRODUCT SPECIFICATION
For 2.00 mm (.079") Board to Board Connectors of System CH11

SPEC.NO.: SPCH083A
PAGE: 3/3

	ITEM	TEST CONDITION	REQUIREMENT
9.5	Solder ability	Soldering time: 3 ± 0.5 sec Soldering pot: 245 ± 5°C	Minimum: 95% of immersed area
9.6	Resistance to soldering heat	Soldering time: $7 \pm 3$ sec Soldering pot: $255 \pm 5$ °C	No damage

10. OPERATING TEMPERATURE: -40°C to + 105°C